
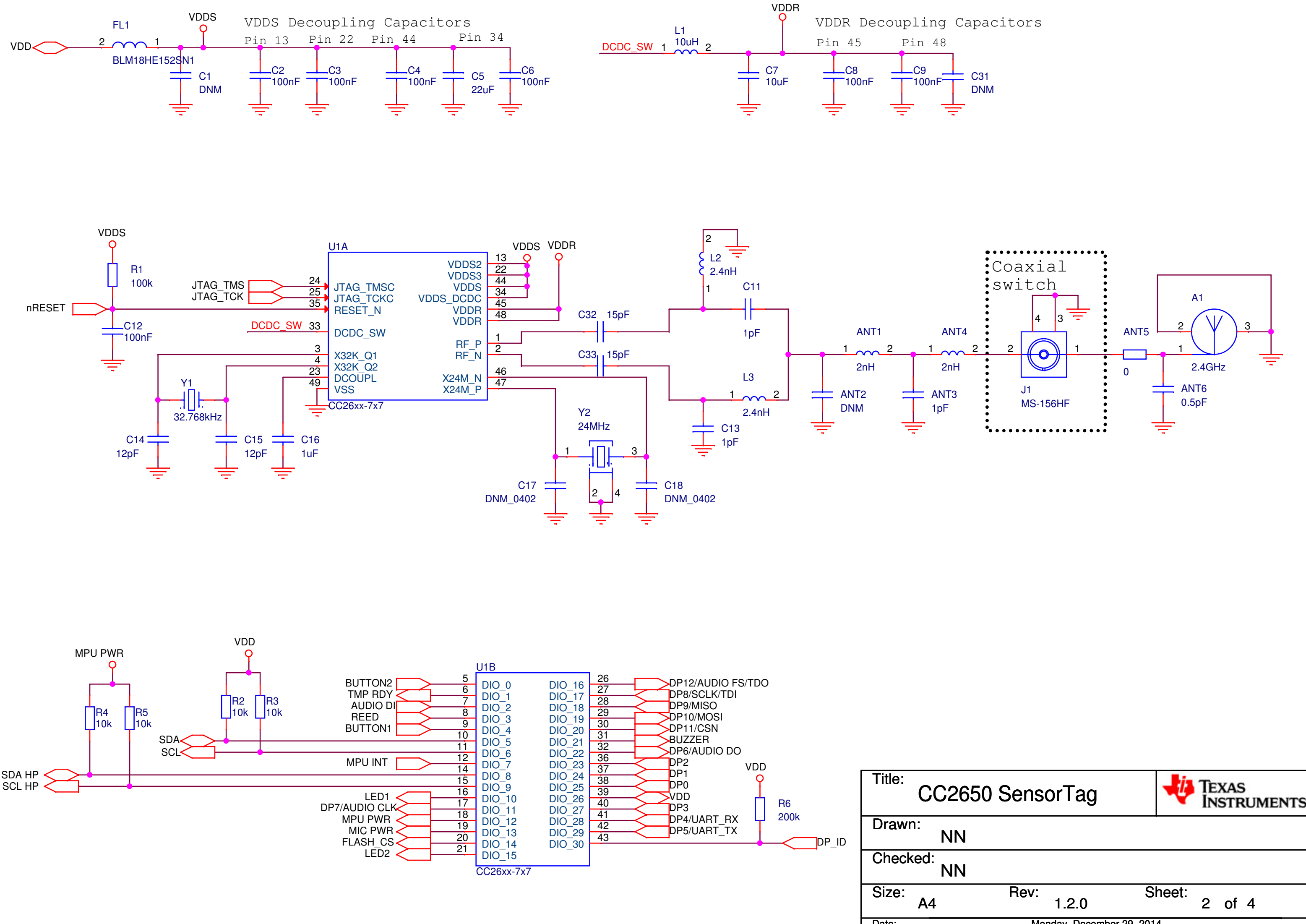

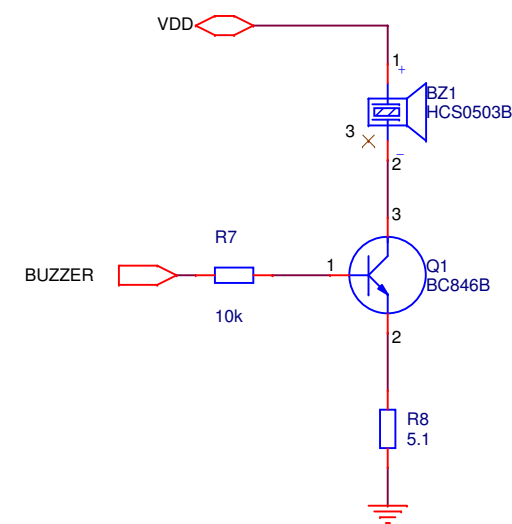


Title: CC2650 SensorTag		 TEXAS INSTRUMENTS	
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Size: A4	Rev: 1.2.0	Sheet: 1 of 4	
Date: Monday, December 29, 2014			

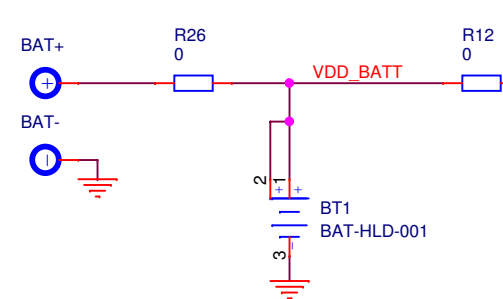


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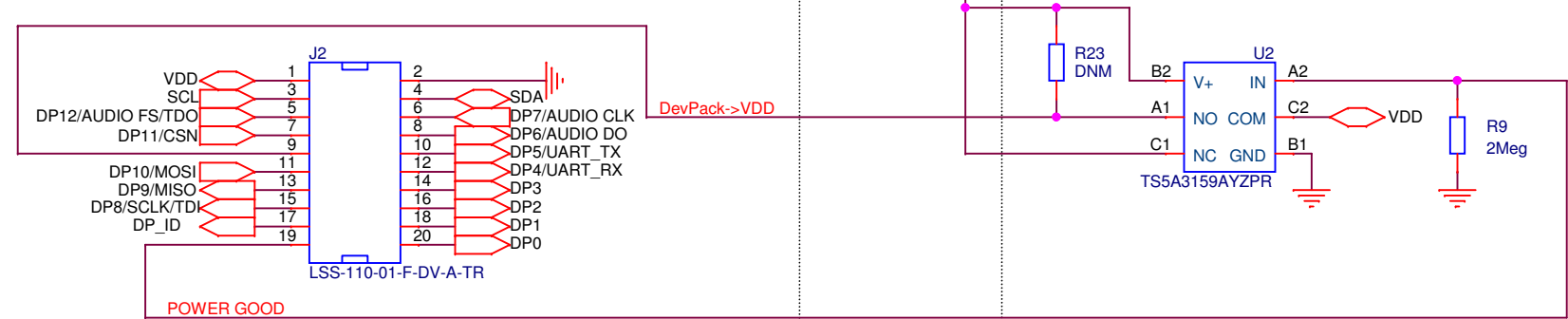
Buzzer



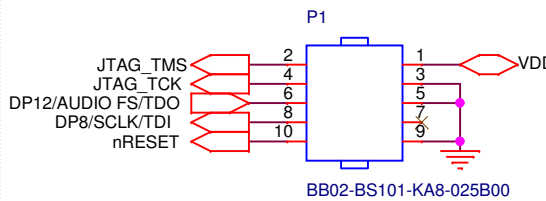
Battery interface



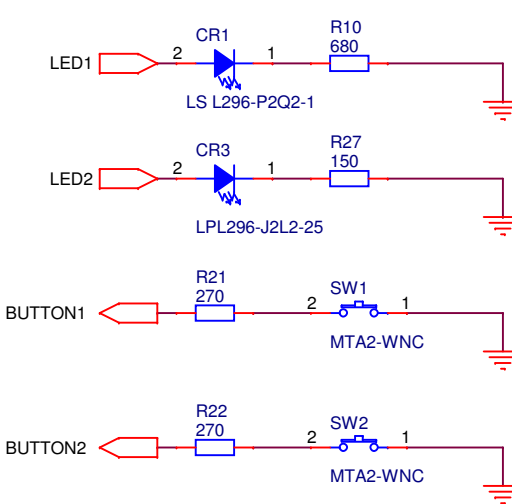
SKIN Connector



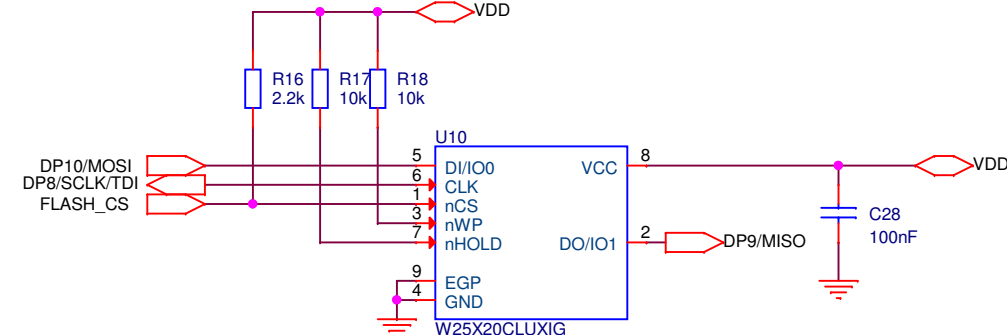
Debug / JTAG interface



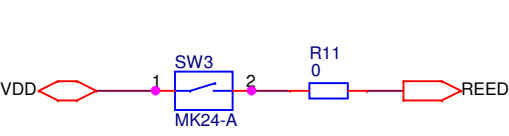
LEDs and Buttons



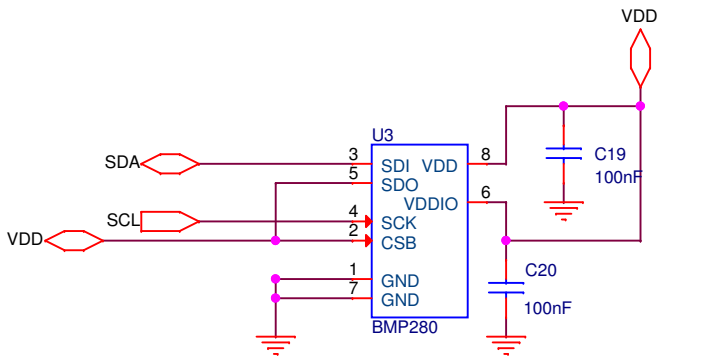
External storage



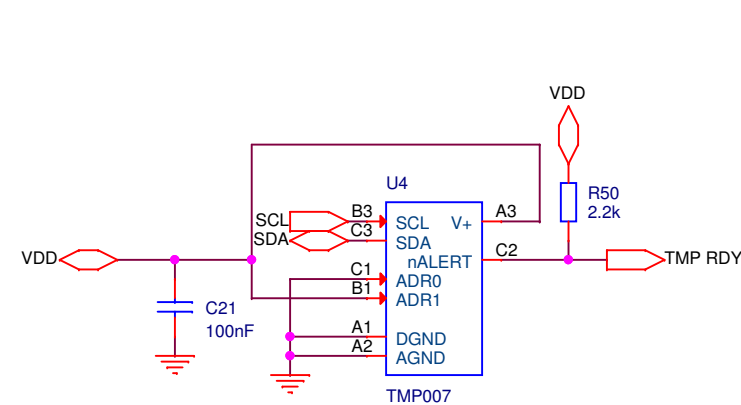
Reed Relay



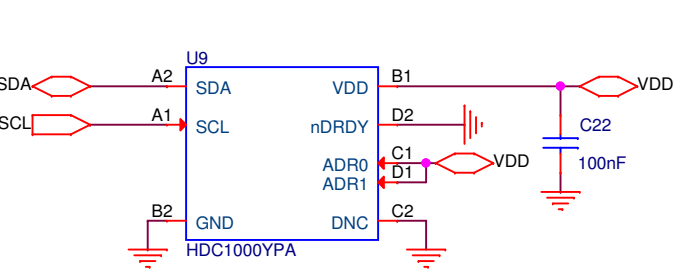
Pressure Sensor



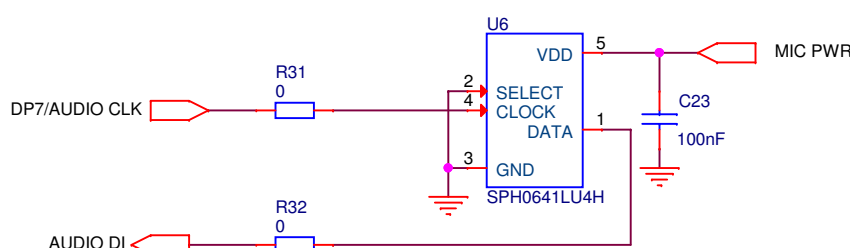
Infrared Thermopile Sensor



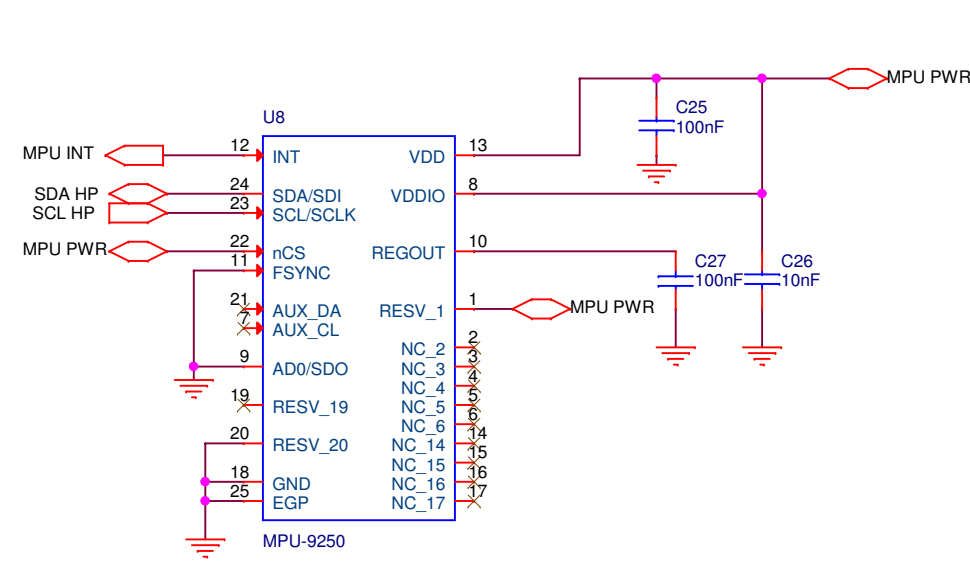
Humidity



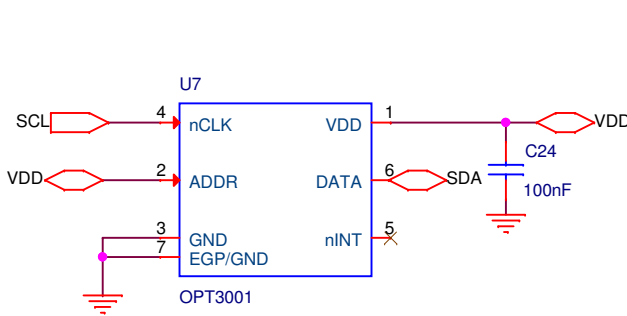
Digital Microphone



Gyroscope and accelerometer



Light Sensor



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